

Precision Ultralow Noise Microphone with Top Port and Analog Output

DESCRIPTION

The ZTS6011E is a high quality, low cost, low power analog output top-ported omni-directional MEMS microphone. ZTS6011E consists of a MEMS microphone element and an preamplifier. ZTS6011E has a high SNR and flat wideband frequency response, resulting in natural sound with high intelligibility. Extra EMI filter for RF noise attenuation is built inside. Due to the built-in filter, ZTS6011E shows high immunity to EMI.

The ZTS6011E is available in a thin 3.76mm × 2.95mm × 1.1mm surface-mount package. It is reflow solder compatible with no sensitivity degradation. The ZTS6011E is halide free.

APPLICATIONS

- Mobile telephones
- PDAs
- Digital video cameras
- Portable media devices with audio input

ORDERING INFORMATION

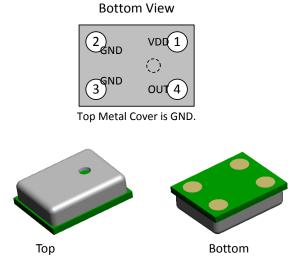
PART	RoHS	Ship, Quantity
ZTS6011E	Yes	Tape and Reel, 5.2K
ZTS6011E-M	Yes	Tape and Reel, 5.2K

Typical Applications



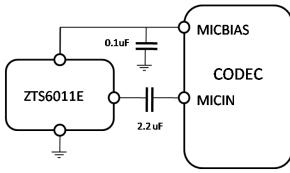
- 3.76mm×2.95mm×1.1mm surface-mount package
- Stable sensitivity over power supply range of 1.5V-3.6V
- SNR of 59dBA
- Sensitivity of -42dBV
- Low current consumption of <150μA
- Multi Chip Module (MCM) Package

Pins Configuration and Description



Isometric Views of ZTS6011E Microphone Package

The ZTS6011E output can be connected to a codec microphone input or to a high input impedance gain stage. A dc-blocking capacitor is required at the output of the microphone.



Connect to Audio Codec

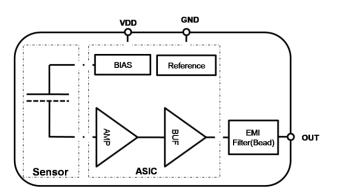


Absolute Maximum Ratings

Supply Voltage	–0.5V to +4V
Sound Pressure Level	160dB
Mechanical Shock	10000g
Vibration	Per MIL-STD-883 Method
	2007, Test Condition B
Temperature Range	40°C to +100°C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Functional Block Diagram



Specifications

 $(T_A = +15^{\circ}C \sim +25^{\circ}C, V_{DD} = +1.8V$, unless otherwise noted.)

PARAMETER	Symbol	TEST CONDITIONS	MIN	ТҮР	МАХ	UNIT
Directivity				Omni		
Supply Voltage	V_{DD}		1.5		3.6	V
Current Consumption	I _{DD}	VDD=1.8V		65	90	μΑ
	I _{DD}	VDD=3.3V		100	150	μΑ
Sensitivity (Note)		1kHz, 94dB SPL	-43	-42	-41	dBV
Signal-to-Noise-Ratio	SNR			59		dBA
Equivalent Input Noise	EIN			35		dBA SPL
Total Harmonic Distortion	THD	110dB SPL @ 1KHz			1	%
Acoustic Overload Point	AOP	10% THD @ 1KHz		128		dBSPL
Power Supply Rejection Ratio	PSRR	217Hz, 100mV Vp-p, square wave on V _{DD}		65		dB
Output Impedance	Zout			200	350	Ω
Output DC Offset				0.70		V
Output Current Limit				90		μΑ
Polarity				Noninverting		

Note: Base on BK sound test system.

DS-1.5 Confidential

Copyright © Zilltek Technology Corp.

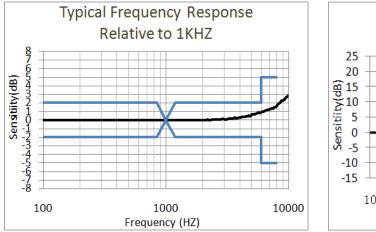
Electro-Static Discharge Sensitivity

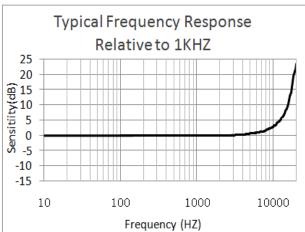
This integrated circuit can be damaged by ESD. It is recommended that all integrated circuits be handled with proper precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure.

Pins Description

Pin	Symbol	Description
1	VDD	Power Supply.
2,3	GND	Ground.
4	OUT	Analog output signal.

Typical Performance Characteristics







TDMA Disturbance Immunity

- 65 dB Max @500 \sim 2500MHz (Direct RF injection test according to set figure , this set figure is based on below block diagram.)

Instrument settings

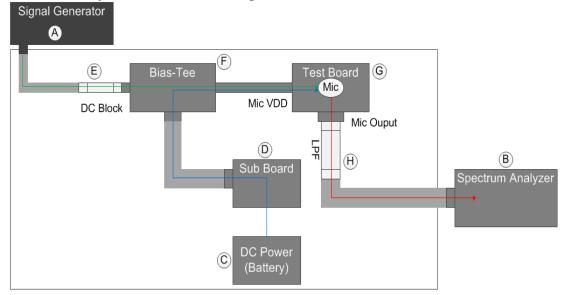
Signal Generator

- modulation: 1 kHz, AM, depth 80%

- test frequency and amplitude from frequency/amplitude table

					<i>n</i>					
MI	Ηz	dBm	MHz	dBm	MHz	dBm	MHz	dBm	MHz	dBm
10	00	-4.08	600	-2.85	1100	-1.64	1600	-0.52	2100	0.05
20	00	-3.68	700	-2.61	1200	-1.33	1700	-0.29	2200	0.12
30	00	-3.31	800	-2.39	1300	-1.25	1800	-0.11	2300	0.27
40	00	-3.24	900	-2.11	1400	-1.08	1900	-0.04	2400	0.31
50	00	-3.09	1000	-1.84	1500	-0.86	2000	-0.01	2500	0.45

RF Immunity Measurement Diagram



А	Signal Generator	Rode & Schwarz SMIQ 03B
В	Spectrum Analyzer	Audio Precision APx525
С	DC Power	Battery 3V
D	Sub Board with RL & Capacitor	C: 0.1uF
Е	DC block	Agilent 11742A
F	Bias-Tee	Mini-Circuits ZFBT-6GW
G	Test Board	ZTS6011E EVB
Н	Low pass filter (Pass band 5M~2.5GHz)	Mini-Circuits SLP-2.5, SLP-5, SLP-150, SLP-450, SLP-1200,SLP-1650

Production Test

Frequency Response

Frequency / Hz	Lower limit	Upper limit	Unit
50 100	-3	+3	
100 8000	-2	+2	
8000 10 000	-5	+5	

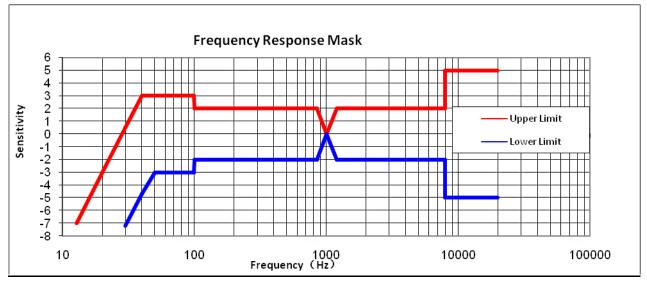


Figure 1: Frequency Response Mask

Distortion Test

	Requirement	Test Conditions		
		Acoustic signal	Position & Speaker	
Distortion at 105 dB SPL	<3% THD+N	1 KHz sinusoidal. 105 dB SPL at test position.	Near Field Speaker	
Distortion at 120 dB SPL	<10% THD+N	1 KHz sinusoidal. 120 dB SPL at test position.	Near Field Speaker	

Noise Floor Test

Microphone should be measured in a silent anechoic chamber. Decimated idle channel noise output is analyzed with FFT, autocorrelation and sonogram. In addition to this, a very low frequency (~1 Hz) low-level sine signal is used to excitate the ADC input and an FFT spectrum of the audio band vs. sine level is plotted. The audio band has to be free from any idle tones and low-level noise-modulation. These can be tested, for example with power spectra and coherent spectra averaging, very low frequency excitation, auto correlation analysis

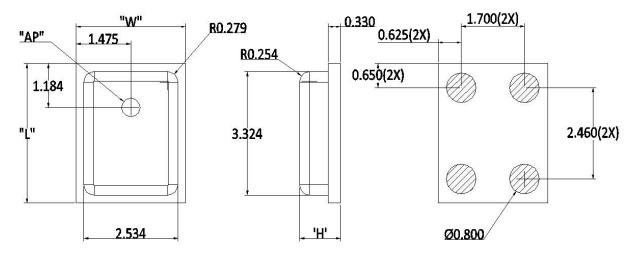


Reliability Tests

The microphone sensitivity after stress must deviate by no more than ± 3 dB from the initial value.

Duration: 1000 hours Voltage: Applied 2. Cold Test, Operational Temperature: $40\pm3^\circ$ C Duration: 1000 hours Voltage: Applied 3. Heat Test, Non-Operational Temperature: $125\pm3^\circ$ C Duration: 1000 hours Voltage: Not Applied 4. Cold Test, Non-Operational Temperature: $-40\pm3^\circ$ C Duration: 1000 hours Voltage: Not Applied 5. Thermal Shock Test, Non-Operational Temperature: $-40\pm3^\circ$ C and $125\pm3^\circ$ C Duration: 30 minutes each, during 5 minutes ramp, 256 cycles Voltage: Not applied 6. Temperature humidity storage Temperature: $85\pm3^\circ$ C Humidity: $85\pm3^\circ$ RH Duration: 1000 hours 7. Free Fall Test 1.5m Placed inside test fixture and dropped on concrete from height 1.5m. 4 times by each surface and corner 8. Vibration 4 cycles of 20 to 2000 Hz sinusoidal sweep with 20G peak acceleration lasting 12 minutes in X, Y, and Z directions 9. Mechanical Shock 5 pulses of 10000g in each of the $\pm X, \pm Y,$ and $\pm Z$ directions 10. Electrostatic Discharge Test Capacitance: 150pF Resistance: 3300 Duration: 10 times Air Discharge: Level 4 (+/-15kV) 11. Human Body Mode ± 2000 Volt 12. Charged-Device Model ± 2000 Volt	1 Uport Teat Onemational	Temperature: 125±3 °C
Voltage: Applied 2. Cold Test, Operational Temperature: $.40\pm3^\circ$ C Duration: 1000 hours Voltage: Applied 3. Heat Test, Non-Operational Temperature: $125\pm3^\circ$ C Duration: 1000 hours Voltage: Not Applied 4. Cold Test, Non-Operational Temperature: $.40\pm3^\circ$ C Duration: 1000 hours Voltage: Not Applied 5. Thermal Shock Test, Non-Operational Temperature: $.40\pm3^\circ$ C and $125\pm3^\circ$ C Duration: 30 minutes each, during 5 minutes ramp, 256 cycles Voltage: Not applied Second 6. Temperature humidity storage Temperature: $.85\pm3^\circ$ C Humidity: $.95\pm3^\circ$ RH Duration: 1000 hours Duration: 1000 hours Temperature: $.85\pm3^\circ$ C 7. Free Fall Test 1.5m Placed inside test fixture and dropped on concrete from height 1.5m. 4 times by each surface and corner 4 times by each surface and corner 8. Vibration 4 cycles of 20 to 2000 Hz sinusidal sweep with 206 peak acceleration lasting 12 minutes in X, Y, and Z directions 9. Mechanical Shock 5 pulses of 10000g in each of the $\pm X, \pm Y,$ and $\pm Z$ directions 10. Electrostatic Discharge Test Capacitance: 1500F <	1. Heat Test, Operational	•
2. Cold Test, Operational Temperature: -40±3°C Duration: 1000 hours Voltage: Applied 3. Heat Test, Non-Operational Temperature: 125±3°C Duration: 1000 hours Voltage: Not Applied 4. Cold Test, Non-Operational Temperature: -40±3°C Duration: 1000 hours Voltage: Not Applied 5. Thermal Shock Test, Non-Operational Temperature: -40±3°C and 125±3°C Duration: 30 minutes each, during 5 minutes ramp, 256 cycles Voltage: Not applied Temperature: 85±3°C 6. Temperature humidity storage Temperature: 85±3°C Humidity: 85±3%RH Duration: 1000 hours Duration: 1000 hours Voltage: Not applied 6. Temperature humidity storage Temperature: 85±3°C Humidity: 95±3%RH Duration: 1000 hours Temperature: 65±3°C Humidity: 95±3%RH Duration: 1000 hours 2000 Hz sinusoidal sweep with 205 geak acceleration lasting 12 minutes in X, Y and Z directions 9. Mechanical Shock 5 pulses of 10000g in each of the ±X, ±Y, and ±Z directions 10. Electrostatic Discharge Test Capacitance: 150pF Resistance: 3300 Duration: 10 times Air Discharge: Level 4 (+/-8kV)		
Duration: 1000 hours Voltage: Applied3. Heat Test, Non-OperationalTemperature: 125±3°C Duration: 1000 hours Voltage: Not Applied4. Cold Test, Non-OperationalTemperature: -40±3°C Duration: 1000 hours Voltage: Not Applied5. Thermal Shock Test, Non-OperationalTemperature: -40±3°C and 125±3°C Duration: 30 minutes each, during 5 minutes ramp, 256 cycles Voltage: Not applied6. Temperature humidity storageTemperature: 85±3°C Humidity: 85±3%RH Duration: 1000 hours7. Free Fall Test 1.5mPlaced inside test fixture and dropped on concrete from height 1.5m. 4 times by each surface and corner8. Vibration4 cycles of 20 to 2000 Hz sinusoidal sweep with 20G peak acceleration lasting 12 minutes in X, Y, and Z directions9. Mechanical Shock5 pulses of 10000g in each of the ±X, ±Y, and ±Z directions10. Electrostatic Discharge TestCapacitance: 150pF Resistance: 330Q Duration: 10 times Air Discharge: Level 4 (+/-5kV) Direct contact discharge: Level 4 (+/-5kV)11. Human Body Mode±2000 Volt12. Charged-Device Model±250 Volt		
Voltage: Applied3. Heat Test, Non-OperationalTemperature: 125±3°C Duration: 1000 hours Voltage: Not Applied4. Cold Test, Non-OperationalTemperature: -40±3°C Duration: 1000 hours 	2. Cold lest, Operational	
3. Heat Test, Non-Operational Temperature: 125±3°C Duration: 1000 hours Voltage: Not Applied 4. Cold Test, Non-Operational Temperature: -40±3°C Duration: 1000 hours Voltage: Not Applied 5. Thermal Shock Test, Non-Operational Temperature: -40±3°C and 125±3°C Duration: 30 minutes each, during 5 minutes ramp, 256 cycles Voltage: Not Applied Temperature: 85±3°C 6. Temperature humidity storage Temperature: 85±3°C Humidity: 85±3%RH Duration: 1000 hours Duration: 1000 hours Temperature: 65±3°C Humidity: 85±3%RH Duration: 168 hours 7. Free Fall Test 1.5m Placed inside test fixture and dropped on concrete from height 1.5m. 4 times by each surface and corner 4 cycles of 20 to 2000 Hz sinusoidal sweep with 20G peak acceleration lasting 12 minutes in X, Y, and Z directions 9. Mechanical Shock 5 pulses of 10000g in each of the ±X, ±Y, and ±Z directions 10. Electrostatic Discharge Test Capacitance: 150pF Resistance: 330Ω Duration: 10 times Air Discharge: Level 4(+/-15kV) Direct contact discharge: Level 4(+/-15kV) 11. Human Body Mode ±2000 volt 12. Charged-Device Model ±2000 volt		
Duration:1000 hours Voltage: Not Applied4. Cold Test, Non-OperationalTemperature:-40±3°C Duration:1000 hours Voltage: Not Applied5. Thermal Shock Test, Non-OperationalTemperature:-40±3°C and 125±3°C Duration:30 minutes each, during 5 minutes ramp, 256 cycles Voltage: Not applied6. Temperature humidity storageTemperature: 85±3°C Humidity: 85±3%RH Duration: 1000 hours6. Temperature humidity storageTemperature: 65±3°C Humidity: 95±3%RH Duration: 1000 hours7. Free Fall Test 1.5mPlaced inside test fixture and dropped on concrete from height 1.5m. 4 times by each surface and corner8. Vibration4 cycles of 20 to 2000 Hz sinusoidal sweep with 20G peak acceleration lasting 12 minutes in X, Y, and Z directions9. Mechanical Shock5 pulses of 10000g in each of the ±X, ±Y, and ±Z directions10. Electrostatic Discharge TestCapacitance: 150pF Resistance: 330Q Duration: 100 times Air Discharge: Level 4 (+/-15kV) Direct contact discharge: Level 4 (+/-8kV)11. Human Body Mode±200 Volt12. Charged-Device Model±200 Volt		
Voltage: Not Applied4. Cold Test, Non-OperationalTemperature: -40±3°C Duration:1000 hours Voltage: Not Applied5. Thermal Shock Test, Non-OperationalTemperature: -40±3°C and 125±3°C Duration: 30 minutes each, during 5 minutes ramp, 256 cycles Voltage: Not applied6. Temperature humidity storageTemperature: 85±3°C Humidity: 85±3%RH Duration: 1000 hours6. Temperature humidity storageTemperature: 65±3°C Humidity: 95±3%RH Duration: 168 hours7. Free Fall Test 1.5mPlaced inside test fixture and dropped on concrete from height 1.5m. 4 times by each surface and corner8. Vibration4 cycles of 20 to 2000 Hz sinusoidal sweep with 20G peak acceleration lasting 12 minutes in X, Y, and Z directions9. Mechanical Shock5 pulses of 10000g in each of the ±X, ±Y, and ±Z directions10. Electrostatic Discharge TestCapacitance: 150pF Resistance: 330Q Duration: 10 times Air Discharge: Level 4(+/-15kV) Direct contact discharge: Level 4(+/-8kV)11. Human Body Mode±2000 Volt12. Charged-Device Model±250 Volt	3. Heat Test, Non-Operational	•
4. Cold Test, Non-Operational Temperature: -40±3°C Duration:1000 hours Voltage: Not Applied 5. Thermal Shock Test, Non-Operational Temperature: -40±3°C and 125±3°C Duration: 30 minutes each, during 5 minutes ramp, 256 cycles Voltage: Not applied Temperature: 85±3°C 6. Temperature humidity storage Temperature: 85±3°C Humidity: 85±3%RH Duration: 1000 hours Temperature: 65±3°C Humidity: 95±3%RH Duration: 1000 hours Temperature: 65±3°C Humidity: 95±3%RH Duration: 168 hours 7. Free Fall Test 1.5m Placed inside test fixture and dropped on concret from height 1.5m. 4 times by each surface and corner 4 tycles of 20 to 2000 Hz sinusoidal sweep with 20G peak acceleration lasting 12 minutes in X, Y and Z directions 9. Mechanical Shock 5 pulses of 10000g in each of the ±X, ±Y, and ±Z directions 10. Electrostatic Discharge Test Capacitance: 150pF Resistance: 330Ω Duration: 10 times Air Discharge: Level 4 (+/-15kV) Direct contact discharge: Level 4 (+/-15kV) 11. Human Body Mode ±2000 Volt 12. Charged-Device Model ±250 Volt		
Duration:1000 hours Voltage: Not Applied5. Thermal Shock Test, Non-OperationalTemperature: -40±3°C and 125±3°C Duration: 30 minutes each, during 5 minutes ramp, 256 cycles Voltage: Not applied6. Temperature humidity storageTemperature: 85±3°C Humidity: 85±3%RH Duration: 1000 hours7. Free Fall Test 1.5mPlaced inside test fixture and dropped on concrete from height 1.5m. 4 times by each surface and corner8. Vibration4 cycles of 20 to 2000 Hz sinusoidal sweep with 20G peak acceleration lasting 12 minutes in X, Y, and Z directions9. Mechanical Shock5 pulses of 10000g in each of the ±X, ±Y, and ±Z directions10. Electrostatic Discharge TestCapacitance: 150pF Resistance: 330Q Duration: 10 times Air Discharge: Level 4 (+/-15kV) Direct contact discharge: Level 4 (+/-8kV)11. Human Body Mode±2000 Volt12. Charged-Device Model5 reflow cycles with peak temperature of		
Voltage: Not Applied5. Thermal Shock Test, Non-OperationalTemperature: -40±3°C and 125±3°CDuration: 30 minutes each, during 5 minutes ramp, 256 cycles Voltage: Not applied6. Temperature humidity storageTemperature: 85±3°C Humidity: 85±3%RH Duration: 1000 hours7. Free Fall Test 1.5mPlaced inside test fixture and dropped on concrete from height 1.5m. 4 times by each surface and corner8. Vibration4 cycles of 20 to 2000 Hz sinusoidal sweep with 20G peak acceleration lasting 12 minutes in X, Y, and Z directions9. Mechanical Shock5 pulses of 10000g in each of the ±X, ±Y, and ±Z directions10. Electrostatic Discharge TestCapacitance: 150pF Resistance: 330Q Duration: 10 times Air Discharge: Level 4 (+/-15kV) Direct contact discharge: Level 4 (+/-15kV)11. Human Body Mode±2000 Volt12. Charged-Device Model5 reflow cycles with peak temperature of	4. Cold Test, Non-Operational	
5. Thermal Shock Test, Non-OperationalTemperature: -40±3°C and 125±3°C Duration: 30 minutes each, during 5 minutes ramp, 256 cycles Voltage: Not applied6. Temperature humidity storageTemperature: 85±3°C Humidity: 85±3%RH Duration: 1000 hours7. Free Fall Test 1.5mPlaced inside test fixture and dropped on concrete from height 1.5m. 4 times by each surface and corner8. Vibration4 cycles of 20 to 2000 Hz sinusoidal sweep with 20G peak acceleration lasting 12 minutes in X, Y, and Z directions9. Mechanical Shock5 pulses of 10000g in each of the ±X, ±Y, and ±Z directions10. Electrostatic Discharge TestCapacitance: 150pF Resistance: 330Ω Duration: 10 times Air Discharge: Level 4(+/-15kV) Direct contact discharge: Level 4(+/-15kV)11. Human Body Mode±2000 Volt12. Charged-Device Model±250 Volt		
Duration: 30 minutes each, during 5 minutes ramp, 256 cycles Voltage: Not applied6. Temperature humidity storageTemperature: 85±3°C Humidity: 85±3%RH Duration: 1000 hours7. Free Fall Test 1.5mPlaced inside test fixture and dropped on concrete from height 1.5m. 4 times by each surface and corner8. Vibration4 cycles of 20 to 2000 Hz sinusoidal sweep with 20G peak acceleration lasting 12 minutes in X, Y, and Z directions9. Mechanical Shock5 pulses of 10000g in each of the ±X, ±Y, and ±Z directions10. Electrostatic Discharge TestCapacitance: 150pF Resistance: 330Ω Duration: 10 times Air Discharge: Level 4(+/-15kV) Direct contact discharge: Level 4(+/-15kV)11. Human Body Mode±2000 Volt12. Charged-Device Model±250 Volt		
minutes ramp, 256 cycles Voltage: Not applied6. Temperature humidity storageTemperature: 85±3°C Humidity: 85±3%RH Duration: 1000 hours6. Temperature: 65±3°C Humidity: 95±3%RH Duration: 1000 hours7. Free Fall Test 1.5mPlaced inside test fixture and dropped on concrete from height 1.5m. 4 times by each surface and corner8. Vibration4 cycles of 20 to 2000 Hz sinusoidal sweep with 20G peak acceleration lasting 12 minutes in X, Y, and Z directions9. Mechanical Shock5 pulses of 10000g in each of the ±X, ±Y, and ±Z directions10. Electrostatic Discharge TestCapacitance: 150pF Resistance: 330Ω Duration: 10 times Air Discharge: Level 4 (+/-15kV) Direct contact discharge: Level 4 (+/-8kV)11. Human Body Mode±2000 Volt12. Charged-Device Model±250 Volt	5. Thermal Shock Test, Non-Operational	Temperature: -40±3°C and 125±3°C
Voltage: Not applied6. Temperature humidity storageTemperature: 85±3°C Humidity: 85±3%RH Duration: 1000 hours7. Free Fall Test 1.5mPlaced inside test fixture and dropped on concrete from height 1.5m. 4 times by each surface and corner8. Vibration4 cycles of 20 to 2000 Hz sinusoidal sweep with 20G peak acceleration lasting 12 minutes in X, Y, and 2 directions9. Mechanical Shock5 pulses of 10000g in each of the ±X, ±Y, and ±Z directions10. Electrostatic Discharge TestCapacitance: 150PF Resistance: 330Q Duration: 10 times Air Discharge: Level 4 (+/-15kV) Direct contact discharge: Level 4 (+/-8kV)11. Human Body Mode±2000 Volt12. Charged-Device Model±250 Volt		Duration: 30 minutes each, during 5
6. Temperature humidity storage Temperature: 85±3°C Humidity: 85±3%RH Duration: 1000 hours Temperature: 65±3°C Humidity: 95±3%RH Duration: 168 hours Temperature: 65±3°C 7. Free Fall Test 1.5m Placed inside test fixture and dropped on concrete from height 1.5m. 4 times by each surface and corner 4 times by each surface and corner 8. Vibration 4 cycles of 20 to 2000 Hz sinusoidal sweep with 20G peak acceleration lasting 12 minutes in X, Y, and Z directions 9. Mechanical Shock 5 pulses of 10000g in each of the ±X, ±Y, and ±Z directions 10. Electrostatic Discharge Test Capacitance: 150pF Resistance: 330Ω Duration: 10 times Air Discharge: Level 4(+/-15kV) Direct contact discharge: Level 4 (+/-8kV) 11. Human Body Mode ±2000 Volt 12. Charged-Device Model ±250 Volt		minutes ramp, 256 cycles
Humidity: 85±3%RH Duration: 1000 hoursTemperature: 65±3°C Humidity: 95±3%RH Duration: 168 hours7. Free Fall Test 1.5mPlaced inside test fixture and dropped on concrete from height 1.5m. 4 times by each surface and corner8. Vibration4 cycles of 20 to 2000 Hz sinusoidal sweep with 20G peak acceleration lasting 12 minutes in X, Y, and Z directions9. Mechanical Shock5 pulses of 10000g in each of the ±X, ±Y, and ±Z directions10. Electrostatic Discharge TestCapacitance: 150pF Resistance: 330Q Duration: 10 times Air Discharge: Level 4(+/-15kV) Direct contact discharge: Level 4 (+/-8kV)11. Human Body Mode±2000 Volt12. Charged-Device Model5 reflow cycles with peak temperature of		Voltage: Not applied
Duration: 1000 hoursTemperature: 65±3°CHumidity: 95±3%RHDuration: 168 hours7. Free Fall Test 1.5mPlaced inside test fixture and dropped on concrete from height 1.5m. 4 times by each surface and corner8. Vibration4 cycles of 20 to 2000 Hz sinusoidal sweep with 20G peak acceleration lasting 12 minutes in X, Y, and Z directions9. Mechanical Shock5 pulses of 10000g in each of the ±X, ±Y, and ±Z directions10. Electrostatic Discharge TestCapacitance: 150pF Resistance: 330Q Duration: 10 times Air Discharge: Level 4 (+/-15kV) Direct contact discharge: Level 4 (+/-8kV)11. Human Body Mode±2000 Volt12. Charged-Device Model±250 Volt13. Reflow5 reflow cycles with peak temperature of	6. Temperature humidity storage	Temperature: 85±3°C
Temperature: 65±3°C Humidity: 95±3%RH Duration: 168 hours7. Free Fall Test 1.5mPlaced inside test fixture and dropped on concrete from height 1.5m. 4 times by each surface and corner8. Vibration4 cycles of 20 to 2000 Hz sinusoidal sweep with 20G peak acceleration lasting 12 minutes in X, Y, and Z directions9. Mechanical Shock5 pulses of 10000g in each of the ±X, ±Y, and ±Z directions10. Electrostatic Discharge TestCapacitance: 150pF Resistance: 330Ω Duration: 10 times Air Discharge: Level 4(+/-15kV) Direct contact discharge: Level 4 (+/-8kV)11. Human Body Mode±2000 Volt12. Charged-Device Model±250 Volt13. Reflow5 reflow cycles with peak temperature of		
Humidity: 95±3%RH Duration: 168 hours7. Free Fall Test 1.5mPlaced inside test fixture and dropped on concrete from height 1.5m. 4 times by each surface and corner8. Vibration4 cycles of 20 to 2000 Hz sinusoidal sweep with 20G peak acceleration lasting 12 minutes in X, Y, and Z directions9. Mechanical Shock5 pulses of 10000g in each of the ±X, ±Y, and ±Z directions10. Electrostatic Discharge TestCapacitance: 150pF Resistance: 330Ω Duration: 10 times Air Discharge: Level 4(+/-15kV) Direct contact discharge: Level 4 (+/-8kV)11. Human Body Mode±2000 Volt12. Charged-Device Model5 reflow cycles with peak temperature of		Duration: 1000 hours
Duration: 168 hours7. Free Fall Test 1.5mPlaced inside test fixture and dropped on concrete from height 1.5m. 4 times by each surface and corner8. Vibration4 cycles of 20 to 2000 Hz sinusoidal sweep with 20G peak acceleration lasting 12 minutes in X, Y, and Z directions9. Mechanical Shock5 pulses of 10000g in each of the ±X, ±Y, and ±Z directions10. Electrostatic Discharge TestCapacitance: 150pF Resistance: 330Ω Duration: 10 times Air Discharge: Level 4 (+/-15kV) Direct contact discharge: Level 4 (+/-8kV)11. Human Body Mode±2000 Volt ±250 Volt13. Reflow5 reflow cycles with peak temperature of		Temperature: 65±3°C
7. Free Fall Test 1.5mPlaced inside test fixture and dropped on concrete from height 1.5m. 4 times by each surface and corner8. Vibration4 cycles of 20 to 2000 Hz sinusoidal sweep with 20G peak acceleration lasting 12 minutes in X, Y, and Z directions9. Mechanical Shock5 pulses of 10000g in each of the ±X, ±Y, and ±Z directions10. Electrostatic Discharge TestCapacitance: 150pF Resistance: 330Ω Duration: 10 times Air Discharge: Level 4(+/-15kV) Direct contact discharge: Level 4 (+/-8kV)11. Human Body Mode±2000 Volt12. Charged-Device Model±250 Volt13. Reflow5 reflow cycles with peak temperature of		,
concrete from height 1.5m. 4 times by each surface and corner8. Vibration4 cycles of 20 to 2000 Hz sinusoidal sweep with 20G peak acceleration lasting 12 minutes in X, Y, and Z directions9. Mechanical Shock5 pulses of 10000g in each of the ±X, ±Y, and ±Z directions10. Electrostatic Discharge TestCapacitance: 150pF Resistance: 330Q Duration: 10 times Air Discharge: Level 4(+/-15kV) Direct contact discharge: Level 4(+/-8kV)11. Human Body Mode±2000 Volt12. Charged-Device Model5 reflow cycles with peak temperature of		Duration: 168 hours
4 times by each surface and corner8. Vibration4 cycles of 20 to 2000 Hz sinusoidal sweep with 20G peak acceleration lasting 12 minutes in X, Y, and Z directions9. Mechanical Shock5 pulses of 10000g in each of the ±X, ±Y, and ±Z directions10. Electrostatic Discharge TestCapacitance: 150pF Resistance: 330Q Duration: 10 times Air Discharge: Level 4(+/-15kV) Direct contact discharge: Level 4(+/-48kV)11. Human Body Mode±2000 Volt12. Charged-Device Model5 reflow cycles with peak temperature of	7. Free Fall Test 1.5m	Placed inside test fixture and dropped on
8. Vibration4 cycles of 20 to 2000 Hz sinusoidal sweep with 20G peak acceleration lasting 12 minutes in X, Y, and Z directions9. Mechanical Shock5 pulses of 10000g in each of the ±X, ±Y, and ±Z directions10. Electrostatic Discharge TestCapacitance: 150pF Resistance: 330Ω Duration: 10 times Air Discharge: Level 4(+/-15kV) Direct contact discharge: Level 4(+/-15kV) Direct contact discharge: Level 4 (+/-8kV)11. Human Body Mode±2000 Volt12. Charged-Device Model5 reflow cycles with peak temperature of		concrete from height 1.5m.
with 20G peak acceleration lasting 12 minutes in X, Y, and Z directions9. Mechanical Shock5 pulses of 10000g in each of the ±X, ±Y, and ±Z directions10. Electrostatic Discharge TestCapacitance: 150pF Resistance: 330Ω Duration: 10 times Air Discharge: Level 4(+/-15kV) Direct contact discharge: Level 4(+/-15kV) Direct contact discharge: Level 4 (+/-8kV)11. Human Body Mode±2000 Volt12. Charged-Device Model5 reflow cycles with peak temperature of		4 times by each surface and corner
minutes in X, Y, and Z directions9. Mechanical Shock5 pulses of 10000g in each of the ±X, ±Y, and ±Z directions10. Electrostatic Discharge TestCapacitance: 150pF Resistance: 330Ω Duration: 10 times Air Discharge: Level 4(+/-15kV) Direct contact discharge: Level 4(+/-8kV)11. Human Body Mode±2000 Volt12. Charged-Device Model5 reflow cycles with peak temperature of	8. Vibration	4 cycles of 20 to 2000 Hz sinusoidal sweep
9. Mechanical Shock5 pulses of 10000g in each of the ±X, ±Y, and ±Z directions10. Electrostatic Discharge TestCapacitance: 150pF Resistance: 330Ω Duration: 10 times Air Discharge: Level 4(+/-15kV) Direct contact discharge: Level 4(+/-15kV)11. Human Body Mode±2000 Volt12. Charged-Device Model±250 Volt13. Reflow5 reflow cycles with peak temperature of		with 20G peak acceleration lasting 12
and ±Z directions10. Electrostatic Discharge TestCapacitance: 150pF Resistance: 330Ω Duration: 10 times Air Discharge: Level 4(+/-15kV) Direct contact discharge: Level 4(+/-15kV)11. Human Body Mode±2000 Volt12. Charged-Device Model±250 Volt13. Reflow5 reflow cycles with peak temperature of		minutes in X, Y, and Z directions
10. Electrostatic Discharge TestCapacitance: 150pF Resistance: 330Ω Duration: 10 times Air Discharge: Level 4(+/-15kV) Direct contact discharge: Level 4(+/-15kV)11. Human Body Mode±2000 Volt12. Charged-Device Model±250 Volt13. Reflow5 reflow cycles with peak temperature of	9. Mechanical Shock	5 pulses of 10000g in each of the $\pm X$, $\pm Y$,
10. Electrostatic Discharge TestCapacitance: 150pF Resistance: 330Ω Duration: 10 times Air Discharge: Level 4(+/-15kV) Direct contact discharge: Level 4(+/-15kV)11. Human Body Mode±2000 Volt12. Charged-Device Model±250 Volt13. Reflow5 reflow cycles with peak temperature of		and $\pm Z$ directions
Resistance: 330ΩDuration: 10 timesAir Discharge: Level 4(+/-15kV)Direct contact discharge: Level 4 (+/-8kV)11. Human Body Mode± 2000 Volt12. Charged-Device Model± 250 Volt13. Reflow5 reflow cycles with peak temperature of	10. Electrostatic Discharge Test	Capacitance: 150pF
Duration: 10 timesAir Discharge: Level 4(+/-15kV)Direct contact discharge: Level 4 (+/-8kV)Direct contact discharge: Level 4 (+/-8kV)11. Human Body Mode± 2000 Volt12. Charged-Device Model± 250 Volt13. Reflow5 reflow cycles with peak temperature of	0	
Air Discharge: Level 4(+/-15kV) Direct contact discharge: Level 4 (+/-8kV)11. Human Body Mode±2000 Volt12. Charged-Device Model±250 Volt13. Reflow5 reflow cycles with peak temperature of		
Direct contact discharge: Level 4 (+/-8kV)11. Human Body Mode±2000 Volt12. Charged-Device Model±250 Volt13. Reflow5 reflow cycles with peak temperature of		
11. Human Body Mode± 2000 Volt12. Charged-Device Model± 250 Volt13. Reflow5 reflow cycles with peak temperature of		
12. Charged-Device Model± 250 Volt13. Reflow5 reflow cycles with peak temperature of	11. Human Body Mode	
13. Reflow 5 reflow cycles with peak temperature of		
		260°
14. Solderability 245±5°C ,5sec, 95% Tin on pad surface	14. Solderability	
15. Tumble test300 tumbles from a height of 1m onto a steel base.	15. Tumble test	
16. HAST Temperature: 130±3°C	16. HAST	Temperature: 130±3°C
Humidity: 85±3%RH		Humidity: 85±3%RH
Duration: 96 hours		Duration: 96 hours
Voltage: Applied		Voltage: Applied
17. Air Blow 0.45MPa, distance 3cm, time 10s	17. Air Blow	

MECHANICAL SPECIFICATIOPNS

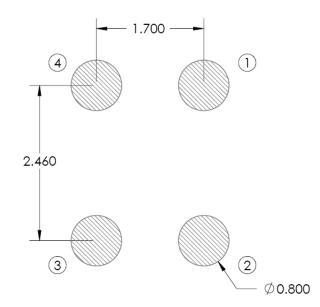


ITEM	DIMENSION	TOLERANCE	UNITS
Length (L)	3.760	±0.100	mm
Width (W)	2.950	±0.100	mm
Height (H)	1.100	±0.100	mm
Acoustic Port (AP)	Ø0.500	±0.050	mm



RECOMMENDED CUSTOMER LAND PATTERN

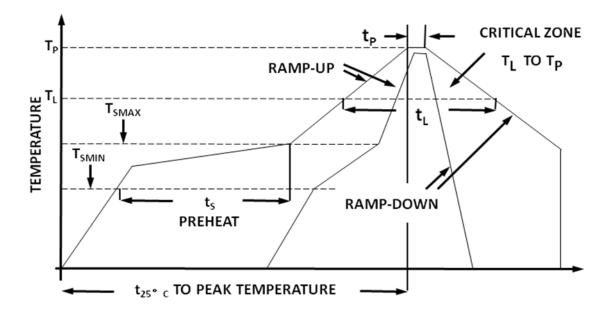
The recommended PCB land pattern for the ZTS6011E should have a 1:1 ratio to the solder pads on the microphone package. Care should be taken to avoid applying solder paste to the sound hole in PCB. The dimensions of suggested solder paste pattern refer to the land pattern **which should be shrunk by 0.025 per side**.





SOLDER FLOW PROFILE

The reflow profile specified in this section describes expected maximum heat exposure of components during the reflow process of NMP product PWBs. Temperature is measured on top of component. All components have to tolerate at least this profile five times (5x) without affecting electrical performance, mechanical performance or reliability.

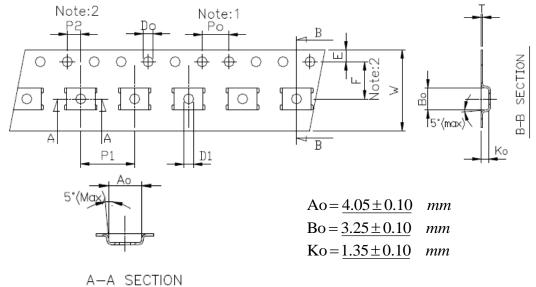


Ph-free and Sn63/Ph37 reflow	profile requirements for soldering heat r	esistance
FU-filee and Shog FUS7 fellow	nome requirements for soluering heat r	esistance.

Parameter Average Ramp Rate		Reference	Pb-Free	Sn63/Pb37 1.25 °C /sec max
		T _L to T _P	1.25°C/sec max	
	Minimum Temperature	T _{SMIN}	100°C	100 °C
Prehear	Maximum Temperature	T _{SMAX}	200°C	150 °C
	Time	T_{SMIN} to T_{SMAX}	60sec to 120sec	60sec to 120sec
Ramp-Up Ra	ite	T_{SMAX} to T_L	1.25°C/sec	1.25 °C /sec
Time Mainta	ained Above Liquidous	tL	60sec to 150sec	60sec to 150sec
Liquidous Te	emperature	TL	217°C	183 °C
Peak Tempe	rature	T _P	260°C +0°C/-5°C	215 °C +3 °C /-3 °C
Time Within +5°C of Actual Peak Temperature		t _P	20 sec to 30 sec	20 sec to 30 sec
Ramp-Down Rate		T _{peak}	6°C/sec max	6 °C /sec max
Time +25 ^o C (t_{250C}) to Peak Temperature			8 min max	6 min max



ZTS6011E PACKAGING



Unit	:	mm
------	---	----

Symbol	Spec.
К1	-
Po	4.0 ± 0.10
P1	8.0 ± 0.10
P2	2.0 ± 0.05
D _o	1.55 ± 0.05
D1	1.50 (MIN)
E	1.75 ± 0.10
F	5.50 ± 0.05
10P ₀	40.0 ± 0.10
W	12.0 ± 0.20
Т	0.30 ± 0.05

Notice :

 $1 \cdot 10$ Sprocket hole pitch cumulative tolerance is ± 0.1 mm.

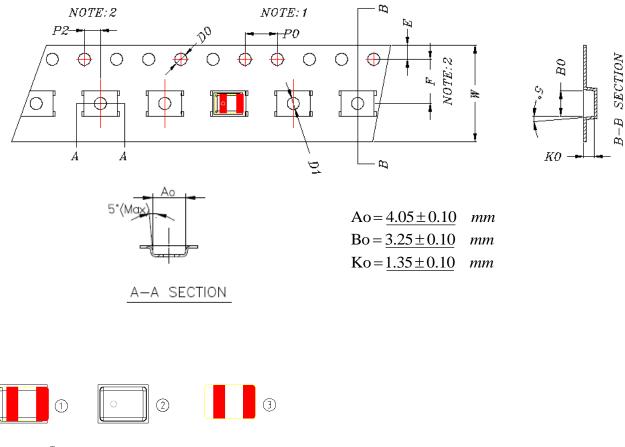
2 · Pocket position relative to sprocket hole measured as true position of pocket not pocket hole.

 $3 \cdot A_0 \& B_0$ measured on a place 0.3mm above the bottom of the pocket to top surface of the carrier.

 $4\cdot K_{0}$ measured from a plane on the inside bottom of the pocket to the top surface of the carrier.

5 · Carrier camber shall be not that 1mm per 100mm through a length of 250mm.

ZTS6011E-M PACKAGING



NOTE: (1) Net Mylar microphone

2 Mic

(3) Mylar (Red part does not contain glue)

Unit	:	mm
Unit	•	

Symbol	Spec.
К1	-
Po	4.0 ± 0.10
P1	8.0 ± 0.10
P2	2.0 ± 0.05
D _o	1.55 ± 0.05
D1	1.50 (MIN)
E	1.75 ± 0.10
F	5.50 ± 0.05
10P ₀	40.0 ± 0.10
W	12.0 ± 0.20
Т	0.30 ± 0.05

Notice :

 $1 \cdot 10$ Sprocket hole pitch cumulative tolerance is ± 0.1 mm.

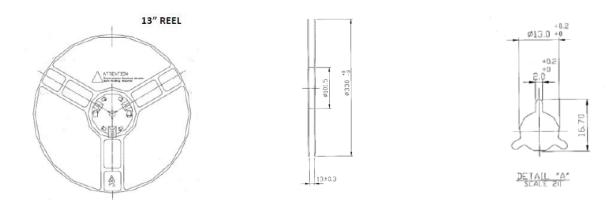
2 · Pocket position relative to sprocket hole measured as true position of pocket not pocket hole.

 $3\,\cdot\,A_{0}$ & B_{0} measured on a place 0.3mm above the bottom of the pocket to top surface of the carrier.

 $4 \cdot K_o$ measured from a plane on the inside bottom of the pocket to the top surface of the carrier.

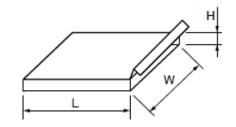
5 · Carrier camber shall be not that 1mm per 100mm through a length of 250mm.





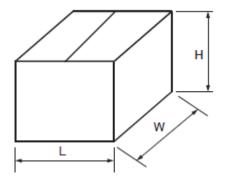
Part NO.	Reel Diameter	Quantity Per Reel	Quantity Per Inner Box	Quantity Per Outer Box
ZTS6011E	13"	5,200	5,200	46,800

Dimensions for Inner Box



Unit:mm			
L	W	н	
335	339	45	

Dimensions for Outer Box



Unit:mm			
L	W	Н	
445	360	372	

Pick and place guidelines of process



Rules of cleaning

Due to Clean the PCBA gap will make MEMS Mic. unit work improperly, please do not clean it by way of ultrasonic or use any cleaning solution to wash the soldered MEMS Mic. unit. If the PCB need to be cleaned, please seal with a tape on the both side of the acoustic hole to avoid foreign material and liquid invaded.

MEMS Mic. is a electro-acoustic component which rely on its diaphragm vibrate in response to sound pressure, so that the sound pressure can be converted to electrical signals; Base on the above, If any cleaning liquid inject the Mic. unit, the vibrate spacing of the diaphragm would be constrained. As a result of that, if the diaphragm cannot vibrate well, it will make the output signal smaller or even no output.

Rules of the pressure of vacuum nozzle

If the Vacuum nozzle pressure is much more on the metal cap, it will directly affect the displacement of the diaphragm structure. When the displacement pressure is greater than the Max input sound pressure, the diaphragm will be damaged or cracked.

Note that Vacuum nozzle pressure cannot greater than 7PSI. 1K Pa = 0.145 pounds (lb / in2) = 0.0102 KGF / CM2 = 0.0098 atm.

Rules of protection measurement

- 1 Please do not let the vacuum nozzle suck the microphone acoustic hole.
- 2 · Do not vacuum the anti-static bag when repackaging the MEMS Mic..
- $3 \cdot Do not blow the acoustic hole when cleaning the PCBA with air gun.$

Rules of the placement of vacuum nozzle

When pick and place the Mic. unit, the SMT Vacuum Tube should be placed in the center of the left and right sides of Mic. unit and keeps 0.5mm from the edge of the acoustic hole.

This pick and place guidelines can apply to all series of ZillTek Top-Port MEMS Mic. products.



